

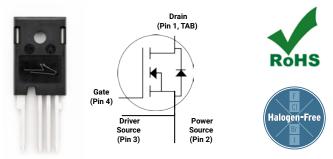
C3M0120065K

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology

N-Channel Enhancement Mode

Features

- C3M[™] SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



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Ordering Part Number	Package	Marking
C3M0120065K	TO-247-4	C3M0120065K

Typical Applications

- Solar inverters
- DC/DC converters
- Switch Mode Power Supplies
- EV battery chargers
- UPS

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			650		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
DC Continuous Drain Current				22	A	V _{GS} = 15 V, T _c = 25 °C, T _J ≤175 °C	Fig. 19 Note 2
	l I _D			16		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	
Pulsed Drain Current	I _{DM}			51		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P _D			98	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-40 to +175	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	650	-	-		$V_{DS} = 0 V, I_{D} = 100 \mu A$		
		1.8	2.3	3.6	V	$V_{DS} = V_{GS}, I_D = 1.86 \text{ mA}$	Fig. 11	
Gate Threshold Voltage	V _{GS(th)}	_	1.9	_		$V_{DS} = V_{GS}$, $I_D = 1.86$ mA, $T_J = 175^{\circ}C$	- Fig. 11	
Zero Gate Voltage Drain Current	I _{DSS}	_	1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I _{GSS}		10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	P	_	120	157	mΩ	$V_{GS} = 15 \text{ V}, I_D = 6.76$	Fig. 4, 5, 6	
Drain-Source On-State Resistance	R _{DS(on)}	_	168	-	11122	$V_{GS} = 15 \text{ V}, I_D = 6.76 , T_J = 175^{\circ}\text{C}$		
Transconductorico			5.0		s	$V_{DS} = 20 \text{ V}, I_{DS} = 6.76 \text{ A}$	F :- 7	
Transconductance	g _{fs}	_	4.9	_	3	$V_{DS} = 20 \text{ V}, I_{DS} = 6.76 \text{ A}, T_{J} = 175^{\circ}\text{C}$	- Fig. 7	
Input Capacitance	C _{iss}	_	640	_		$V_{GS} = 0 V, V_{DS} = 0 V to 400 V$		
Output Capacitance	C _{oss}	_	45	-		f = 1 Mhz	Fig. 17, 18	
Reverse Transfer Capacitance	C _{rss}	_	2.3	_	pF	V _{AC} = 25 mV		
Effective Output Capacitance (Energy Related)	C _{o(er)}	_	57	_				
Effective Output Capacitance (Time Related)	C _{o(tr)}	_	79	_		$V_{GS} = 0 V, V_{DS} = 0 V to 400 V$	Note 3	
C _{oss} Stored Energy	E _{oss}	_	4.3	_		V _{DS} = 400 V, <i>f</i> = 1 Mhz	Fig. 16	
Turn-On Switching Energy (Body Diode)	E _{on}	-	34	_		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}, \text{ I}_{D} = 6.76 \text{ A},$		
Turn Off Switching Energy (Body Diode)	E _{off}	_	7	_	μJ	$\label{eq:R_Gext} \begin{array}{l} R_{G(ext)} = 10 \; \Omega, L = 237 \; \muH, \; T_J = 175^\circC \\ FWD = Internal Body Diode of MOSFET \end{array}$		
Turn-On Switching Energy (External Diode)	Eon	_	27	_		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 6.76 \text{ A},$		
Turn Off Switching Energy (External Diode)	E _{off}	-	7	_		$\label{eq:Gext} \begin{array}{l} R_{G(\mathrm{ext})} = 10 \; \Omega, \; L = 237 \; \mu H, \; T_J = 175^{\circ} C \\ FWD = External \; SiC \; DIODE \end{array}$		
Turn-On Delay Time	t _{d(on)}	_	8	_				
Rise Time	t,	_	11	_		$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 6.76 \text{ A}, R_{G(ext)} = 10 \Omega$		
Turn-Off Delay Time	t _{d(off)}	_	19	_	Timing relative to V _{DS}		Fig. 26	
Fall Time	t _f	_	11	_		Inductive load		
Internal Gate Resistance	R _{G(int)}	_	6	_	Ω	<i>f</i> = 1 MHz, V _{AC} = 25 mV		
Gate to Source Charge	Q _{gs}	_	8	_			Fig. 12	
Gate to Drain Charge	Q _{gd}	_	10	_	nC	$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 6.76 \text{ A}$		
Total Gate Charge	Qg	_	28	_	Per IEC60747-8-4 pg 21			

Note:

 3 C_{o(er),} a lumped capacitance that gives same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Diada Famuard Valtage		4.5	-	v	$V_{GS} = -4 V$, $I_{SD} = 3.4 A$, $T_{J} = 25^{\circ}C$	Fig.
Diode Forward Voltage	V _{SD}	4.0	-		$V_{GS} = -4 V$, $I_{SD} = 3.4 A$, $T_{J} = 175^{\circ}C$	8,9,10
Continuous Diode Forward Current	Is	_	16		V _{GS} = -4 V, T _C = 25°C	
Diode pulse Current	I _{SM}	_	51	A	V _{GS} = -4 V, pulse width t _P limited by T _{jmax}	
Reverse Recover Time	t _{rr}	8	-			
Reverse Recovery Charge	Qrr	119	_	ns	$V_{GS} = -4 V$, $I_{SD} = 6.76 A$, $V_R = 400 V$ dif/dt = 6245 A/µs, $T_J = 175^{\circ}C$	
Peak Reverse Recovery Current	I _{RRM}	22	-			
Reverse Recover Time	t _{rr}	15	_	nC		
Reverse Recovery Charge	Qrr	89	-		$V_{GS} = -4 V$, $I_{SD} = 6.76 A$, $V_{R} = 400 V$ dif/dt = 1845 A/ μ s, $T_{1} = 175^{\circ}$ C	
Peak Reverse Recovery Current	I _{RRM}	10	_	A		

Thermal Characteristics

Parameter	Symbol	Тур.	Unit	Note
Thermal Resistance from Junction to Case	R _{θJC}	1.53	9C (M)	F:- 01
Thermal Resistance From Junction to Ambient	R _{0JA}	40	°C/W	Fig. 21



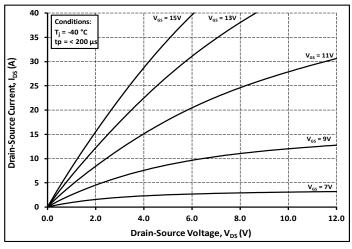
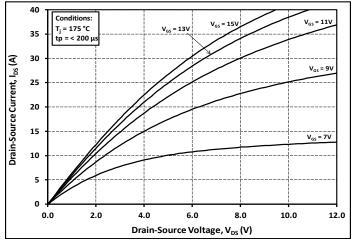
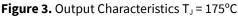
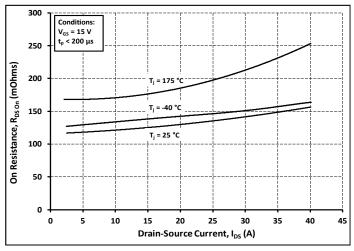
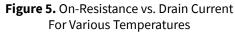


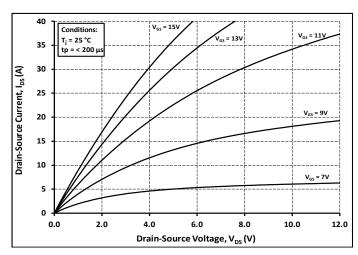
Figure 1. Output Characteristics T_J = -40°C













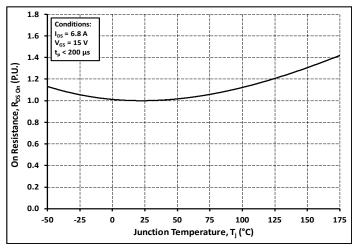
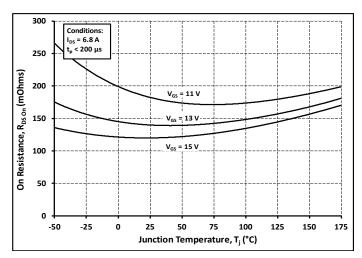
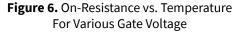


Figure 4. Normalized On-Resistance vs. Temperature

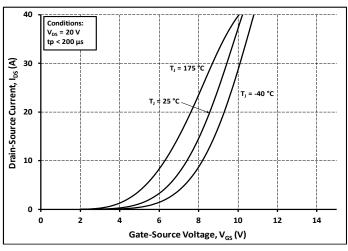


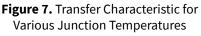


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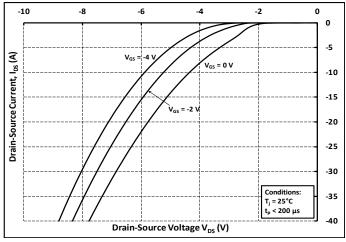
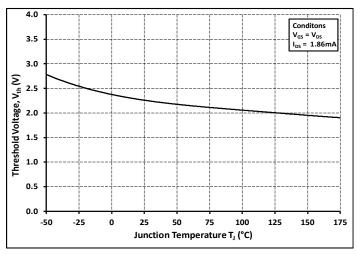
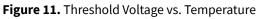


Figure 9. Body Diode Characteristic at 25°C





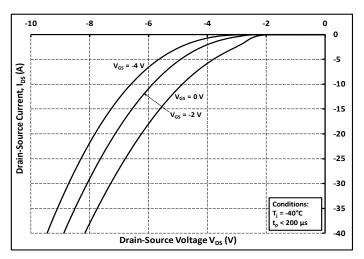


Figure 8. Body Diode Characteristic at -40°C

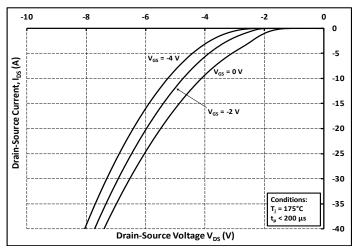


Figure 10. Body Diode Characteristic at 175°C

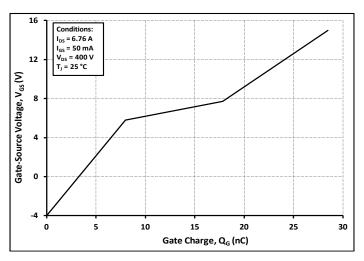


Figure 12. Gate Charge Characteristics

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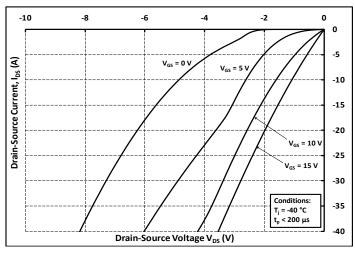


Figure 13. 3rd Quadrant Characteristic at -40°C

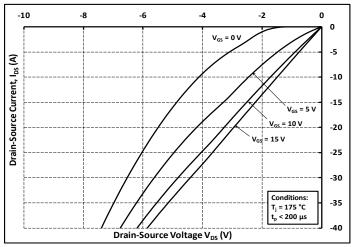
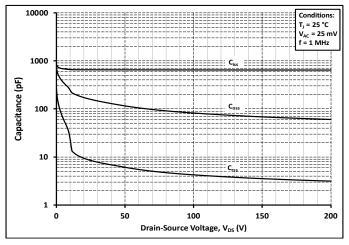
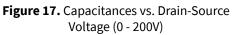


Figure 15. 3rd Quadrant Characteristic at 175°C





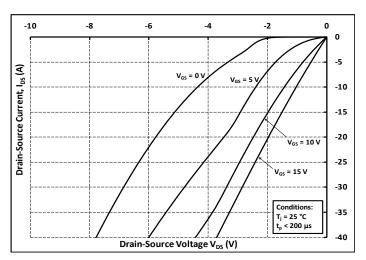


Figure 14. 3rd Quadrant Characteristic at 25°C

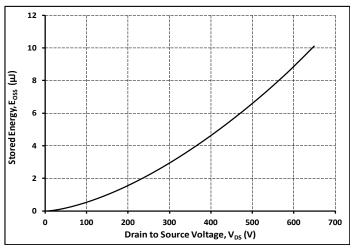


Figure 16. Output Capacitor Stored Energy

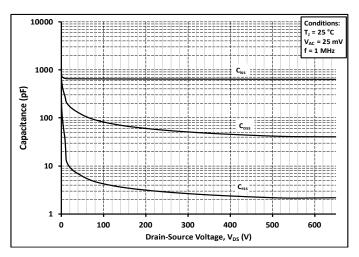
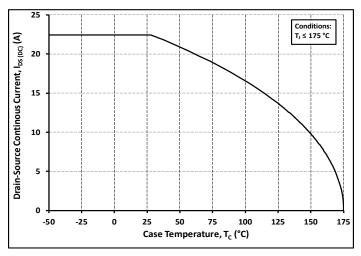


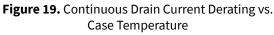
Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)

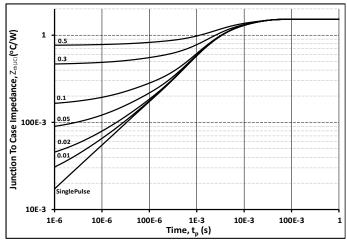
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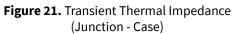
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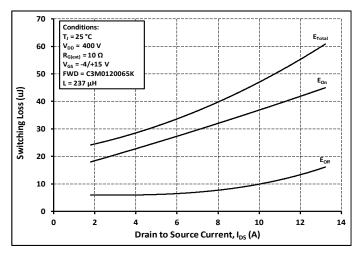


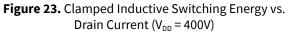












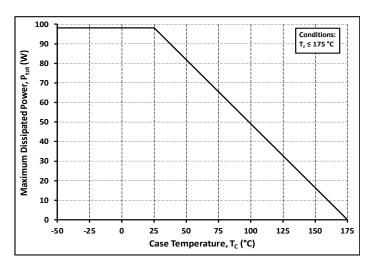


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

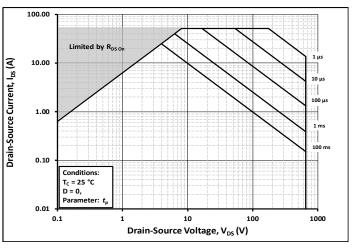
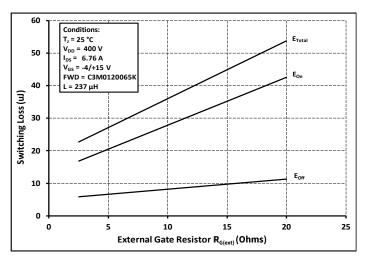
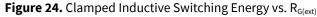


Figure 22. Safe Operating Area





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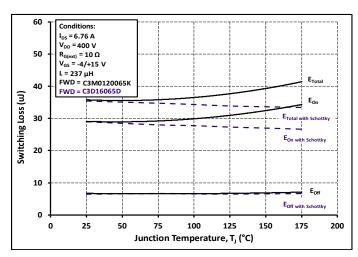


Figure 25. Clamped Inductive Switching Energy vs. Temperature

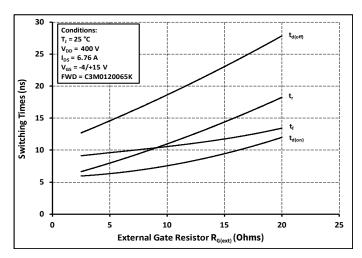


Figure 26. Switching Times vs. $R_{\mbox{\scriptsize G}(\mbox{\scriptsize ext})}$



Test Circuit Schematic

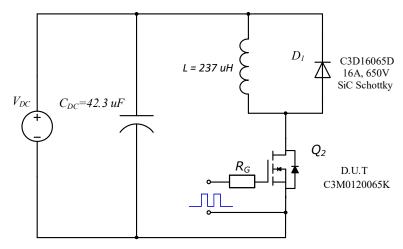


Figure 27. Clamped Inductive Switching Waveform Test Circuit

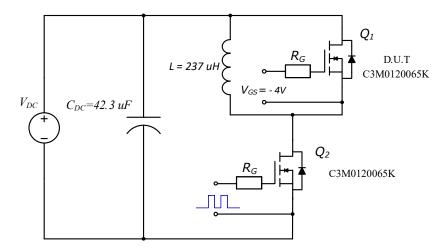
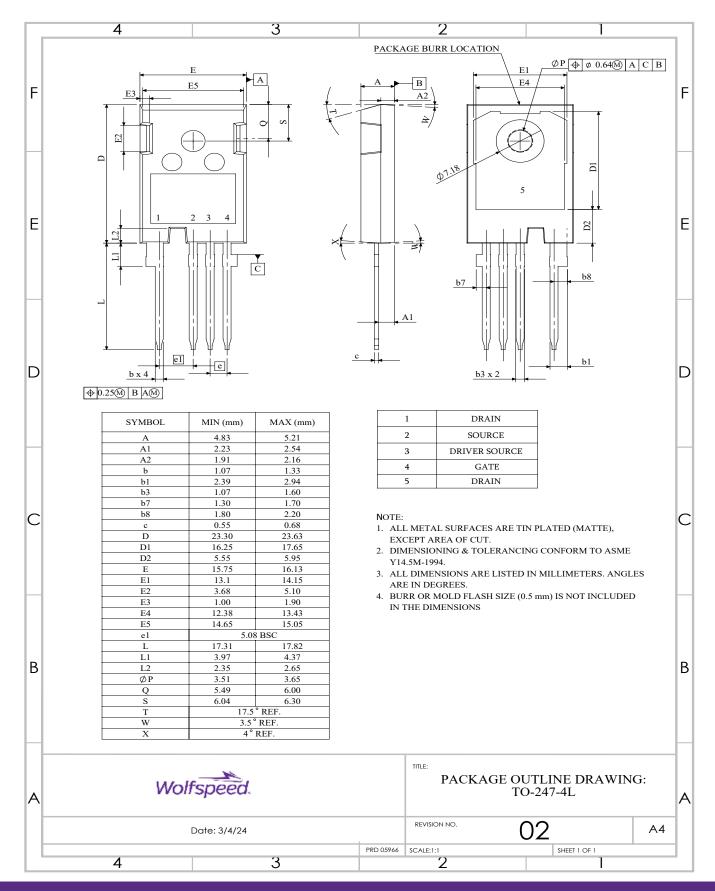


Figure 28. Body Diode Recovery Test Circuit

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Package Dimensions – Package TO-247-4L



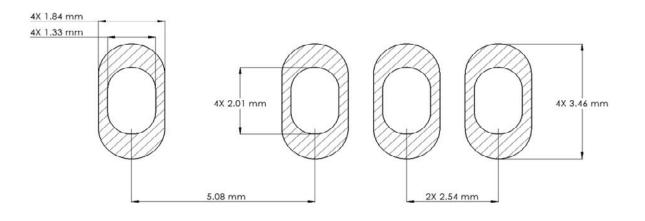
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Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes
1	January-2021	N/A
2	December-2023	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Table 1 layout revised
3	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

Related Links

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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